Winbond Bus Termination Regulator W83310DS/DG

W83310DS Datasheet Revision History

	Pages	Dates	Version	Version on Web	Main Contents
1		May/03	0.5	N.A.	All versions before 0.5 are only for internal use.
2	1	May/03	0.51	N.A.	Typo corrected.
3	5	May/03	0.60	N.A.	Electrical characteristics update.
4	5	Jul./03	0.61	N.A.	Electrical characteristics update.
5	10,11	Feb./04	0.70	N.A.	Package dimension outline and Thermal data.
6	11	Mar./04	0.71	N.A.	Thermal data update.
7	All	Sep./04	0.8	N.A.	Add Pb-free part W83310DG.
8	1	May/05	0.9	N.A.	Add DDR II support spec

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LIFE SUPPORT APPLICATIONS

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1. General Description

The W83310DS/DG is a linear regulator provides a power achieves continuous 2.0Amp bi-directional sinking and driving capability for a high speed bus terminator application. The chip simply implements a stable power supply which tracks half of input power dynamically for bus terminator with a single chip; it's also can be fixed with the input of V_{REF1} and V_{REF2} pins following with setting of pin BOOT_SEL. The W83310DS/DG is promoted with small footprint 8-SOP 150mil power package. With W83310DS/DG design, a high integration, high performance, and cost-effective solution is promoted.

2. Features

- * Regulates a bi-directional power with driving and sinking capability
- Provides achieve continuous 2.0Amp driving and sinking current
- Power MOSFET integrated
- Low external component count
- Low output voltage offset
- ❖ VCNTL Operates with +3.3V & 2.5 V power
- ❖ 8-SOP 150mil small power package
- Low cost and easy to use

3. Applications

- DDR/DDRII Bus Termination Regulator
- ❖ Active Termination Bus
- ❖ Intel® Springdale GMCH-V_{TT} Support
- **❖** SSTL-2
- **❖** SSTL-3



4. Pin Configuration and Description

- W83310DS/DG

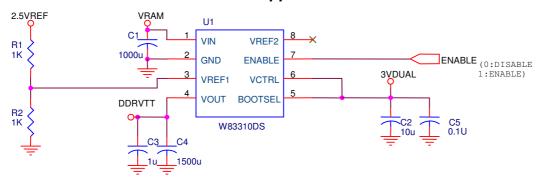


SYMBOL	PIN	FUNCTION		
V _{IN}	1	Main power input pin.		
GND	2	Power ground.		
		Internal reference voltage source 1.		
V_{REF1}	3	Reference voltage on the pin will be referred with the value of pin BOOT_SEL set high.		
V _{OUT} 4		Voltage output pin.		
BOOT_SEL 5		A signal for the chip reference voltage source selection. The function is designed for Intel® Springdale chipset GMCH_ V_{TT} application.		
V _{CNTL} 6		Power for internal control logic use		
ENABLE 7		Chip function enable pin. 1: Enable; 0: Disable		
V _{REF2}	8	Internal reference voltage source 2. Reference voltage of the pin will be referred with the value of pin BOOT_SEL set low.		

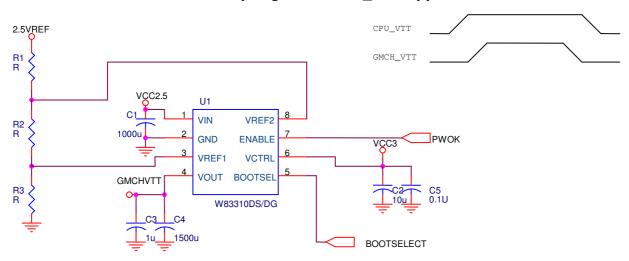


5. Application Circuit

- W83310DS/DG for DDR SDRAM Application



- W83310DS/DG for Intel® Springdale GMCH_VTT Application



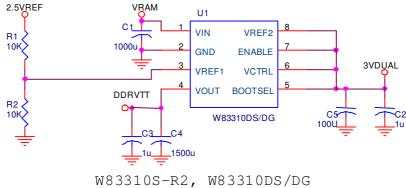
BOOTSELECT=0 GMCHVTT=1.45V for Intel® NORTHWOOD CPU
BOOTSELECT=1 GMCHVTT=1.225V for Intel® PRESCOTT CPU

R1: R2: R3 = 4.66: 1.00: 5.44

Recommend resistor R1=23.2K Ω , R2=4.99K Ω , R3=27.4K Ω

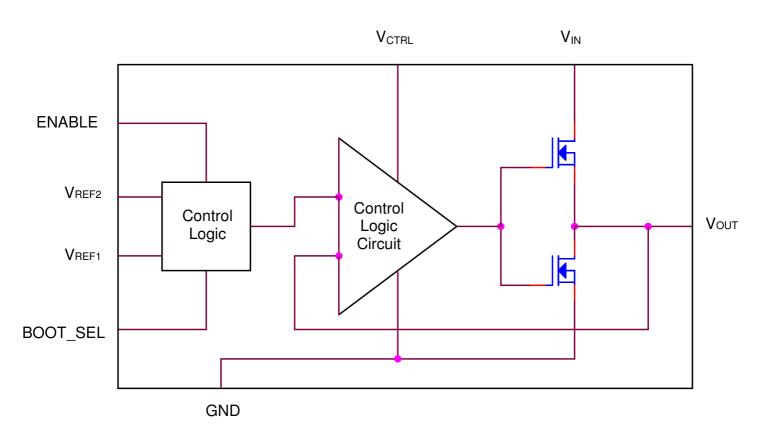


- Dual Layout of W83310DS/DG and W83310S-R2 for DDR V_{TT} Application



DUAL LAYOUT

6. Internal Block Diagram





7. Electrical Characteristics AC CHARACTERISTICS

Cout=1000uF, $T_A = 0$ °C to +70 °C							
Parameter	Symbol	Min	Тур	Max	Units	Test Conditions	
Output Offset Voltage	Vos	-5	0	+5	mV	lout=0A	
Lood Domiletien			0.8		%	Loading: 0A→2.0A	
Load Regulation			8.0		70	Loading: 0A→-2.0A	
Innut Voltage Dange	VIN	1.62		3.63	V		
Input Voltage Range	VCNTL		3.3	3.63	V		
Operating Current of VCNTL	ICNTL		0.5	1	mA	No Load(lout=0A)	
Short Current Limit	ILMT		4.0		Α		

Note: Load regulation is tested by using a 1ms current pulse and V_{OUT} measuring.

Cout=1000uF, T _A = 0°C to +70°C							
Parameter	Symbol	Min	Тур	Max	Units	Test Conditions	
Output Offset Voltage	Vos	-5	0	+5	mV	lout=0A	
Load Regulation			0.8		%	Loading: 0A→2.0A	
Loau negulation			0.8		/0	Loading: 0A→-2.0A	
Input Voltage Range	VIN	1.62		3.63	V		
iliput voltage halige	VCNTL		3.3	3.63	٧		
Operating Current of VCNTL	ICNTL		0.5	1	mA	No Load(lout=0A)	
VREF1 Threshold trigger		0.8			V	Output=High	
VHEFT Tillesiloid (rigger				0.2	V	Output=Low	
BOOT SEL Threshold Trigger		1			V	BOOT_SEL=High	
BOOT_SEL Threshold Trigger				0.2	٧	BOOT_SEL=Low	
Short Current Limit	ILMT		4.0		Α		

Note: Load regulation is tested by using a 1ms current pulse and V_{OUT} measuring.

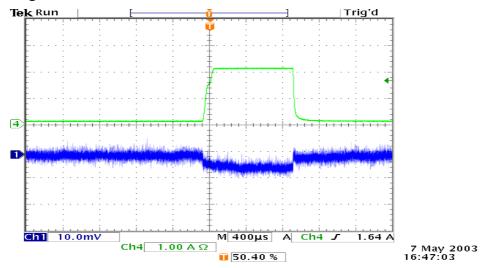
Cout=1000uF, T _A = 0℃ to +70℃							
Parameter	Symbol	Min	Тур	Max	Units	Test Conditions	
Output Offset Voltage	Vos	-5	0	+5	mV	lout=0A	
Load Regulation			8.0		%	Loading: 0A→2.0A	
Load Negulation			0.8		/0	Loading: 0A→-2.0A	
Input Voltage Range	VIN	1.62		3.63	V		
iliput voltage halige	VCNTL		3.3	3.63	٧		
Operating Current of VCNTL	ICNTL		0.5	1	mA	No Load(lout=0A)	
VREF2 Threshold trigger		8.0			V	Output=High	
VNEFZ Tillesilola (liggel				0.2	V	Output=Low	
BOOT SEL Threshold Trigger		1			V	BOOT_SEL=High	
BOOT_SEL THRESHOID TRIGGER				0.2	V	BOOT_SEL=Low	
Short Current Limit	ILMT		4.0		Α		

Note: Load regulation is tested by using a 1ms current pulse and V_{OUT} measuring.

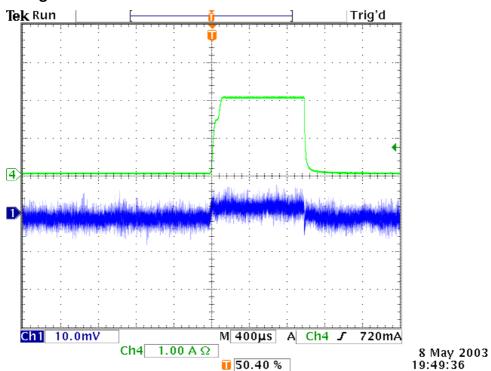


8. Typical Operating Waveform

Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.225V; 2.0Amp pulse driving current.

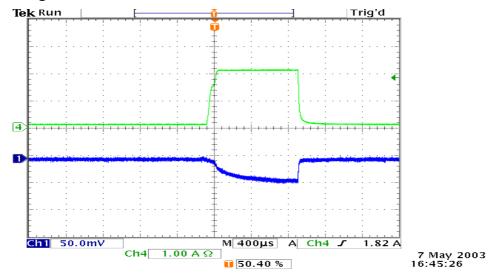


Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.225V; 2.0Amp pulse sinking current.

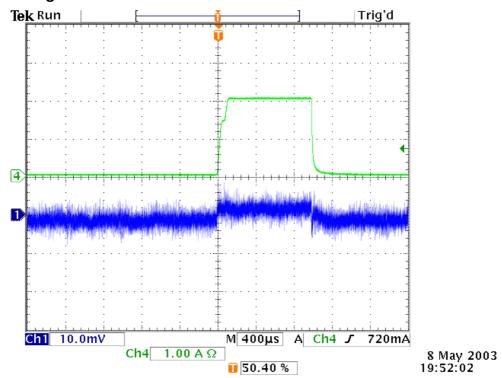




Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.45V; 2.0Amp pulse driving current.



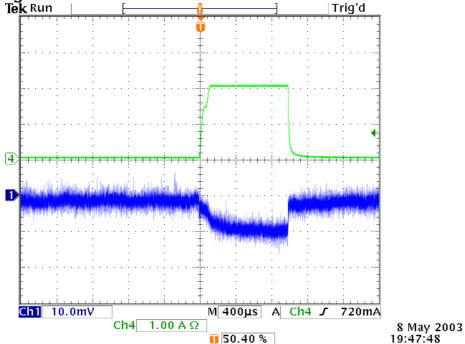
Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.45V; 2.0Amp pulse sinking current.





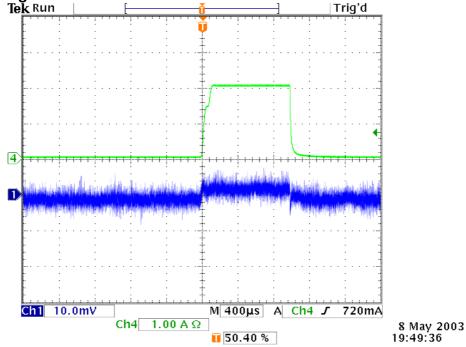
Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 2.0Amp

pulse driving current.



Load regulation with test condition - V_{CTRL} =3.3V; V_{IN} =2.5V; V_{OUT} =1.25V; 2.0Amp

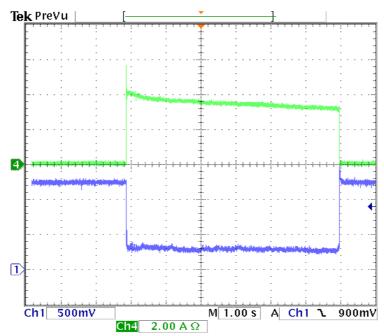
pulse sinking current.





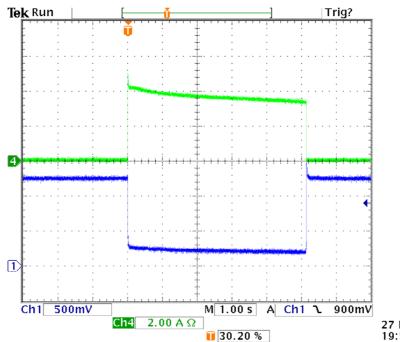
Short Current Limit

 $-V_{CTRL} = 3.3V$



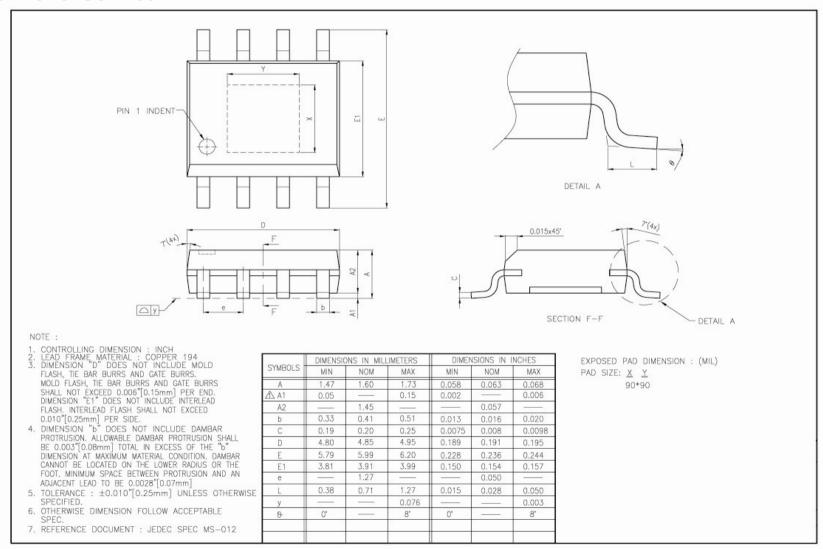
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$-V_{CTRL} = 3.6V$





9. Package Dimension 8L Power SOP 150mil





10. Thermal Performance

Test on Four-Layer (2S2P) JEDEC Test Board								
Package Power (W) Component Temp. (°C)								
Tuonago		Package	Die	Downset	Lead	Ambient	(°C /W)	
PSOP-8	3.05	100	145	79	78	25	14.7	

An area of 190mil*150mil on the top layer is use as a thermal pad for W83310DS and this is connected to the bottom layer by vias. The Θ ja of the W83310DS mounted on this demo board is about 39 °C /W.Assuming the TA=25 °C and TJ=160 °C,the maximum power dissipation is calculated as: PD(max)=(160-25)/39=3.46W

11. Ordering Information

Part Number	Package Type	Production Flow		
W83310DS	Power SOP-8			

12. How to Read the Top Marking





Left line: Winbond logo

1st & 2nd line: W83310DS/DG – the part number

3rd line: Tracking code 318 G A

318: packages assembled in Year 03', week 18

G: assembly house ID; O means OSE, G means GR, etc.

A: the IC version



PRFI IMINARY



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